

## PMEG60T30ELP

# 60 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier

24 May 2018

**Product data sheet** 

## 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP5 (SOD128) small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 3 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- · Capable for reflow and wave soldering
- AEC-Q101 qualified

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling application
- · Reverse polarity protection
- Low power consumption application

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 155$ °C; square wave		-	-	3	А
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	550	620	mV
I <sub>R</sub>	reverse current	$V_R$ = 10 V; pulsed; $T_j$ = 25 °C	[1]	-	0.14	0.9	μΑ
		$V_R$ = 60 V; pulsed; $T_j$ = 25 °C	[1]	-	0.3	1.8	μΑ

[1] Very short pulse, in order to maintain a stable junction temperature.



## 5. Pinning information

## **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		к <b>.}</b> А
2	А	anode	1 2	sym001
			CFP5 (SOD128)	

## 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package						
	Name	Description	Version				
PMEG60T30ELP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128				

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG60T30ELP	E2

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 150 °C		-	4.2	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 155$ °C; square wave		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	0.75	W
			[2]	-	1.2	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

## 9. Thermal characteristics

#### **Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	200	K/W
			[1] [3]	-	-	120	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	12	K/W

<sup>[1]</sup> For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.

<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

<sup>[4]</sup> Soldering point of cathode tab.

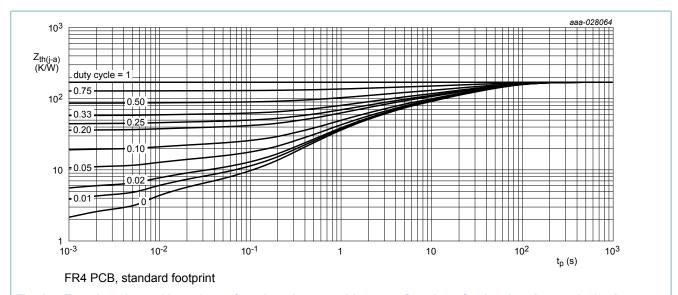


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

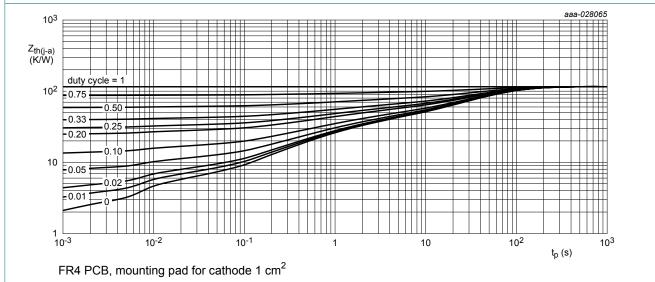


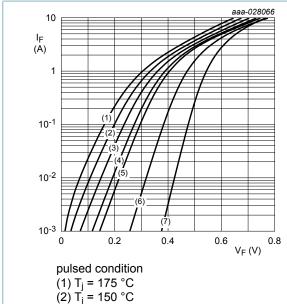
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	I <sub>R</sub> = 1 mA; pulsed; T <sub>j</sub> = 25 °C	[1]	60	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	380	450	mV
		I <sub>F</sub> = 0.5 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	440	510	mV
		I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	470	540	mV
		I <sub>F</sub> = 2 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	515	590	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	550	620	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	610	-	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	480	-	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	0.14	0.9	μΑ
		V <sub>R</sub> = 40 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	0.18	-	μΑ
		V <sub>R</sub> = 60 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	0.3	1.8	μΑ
		V <sub>R</sub> = 60 V; pulsed; T <sub>j</sub> = 125 °C	[1]	-	0.5	-	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	560	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	170	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$		-	16	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	16	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$		-	460	-	mV

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.



 $(3) T_j = 130 °C$ 

 $(4) T_j = 100 °C$ 

 $(5) T_j = 85 ^{\circ}C$ 

(6)  $T_j = 25 \,^{\circ}C$ 

 $(7) T_i = -40 ^{\circ}C$ 

Fig. 3. Forward current as a function of forward voltage; typical values

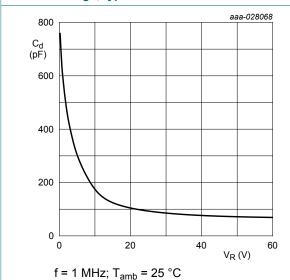
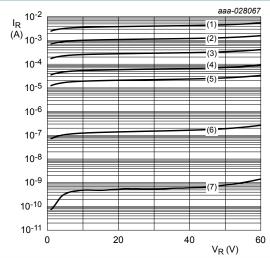


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



pulsed condition

(1)  $T_i = 175 \,^{\circ}C$ 

(2)  $T_j = 150 \, ^{\circ}C$ 

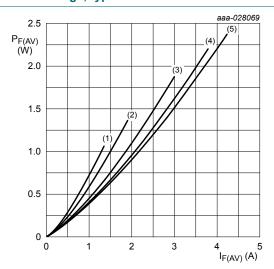
(3)  $T_j = 125 \,^{\circ}\text{C}$ 

 $(4) T_j = 100 °C$ 

(5)  $T_j = 85 ^{\circ}C$ (6)  $T_i = 25 ^{\circ}C$ 

 $(7) T_i = -40 ^{\circ}C$ 

Fig. 4. Reverse current as a function of reverse voltage; typical values



T<sub>i</sub> = 100 °C

 $(1) \delta = 0.1$ 

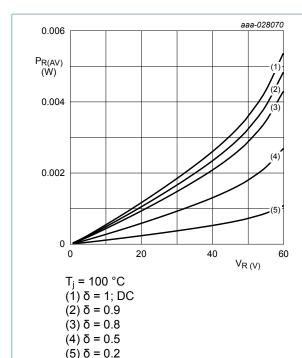
 $(2) \delta = 0.2$ 

 $(3) \delta = 0.5$ 

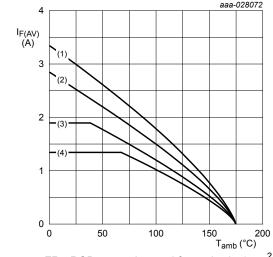
(4)  $\delta = 0.8$ (5)  $\delta = 1$ ; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values

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Average reverse power dissipation as a Fig. 7. function of reverse voltage; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup> T<sub>i</sub> = 175 °C

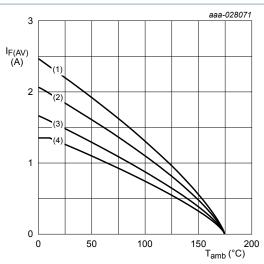
 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

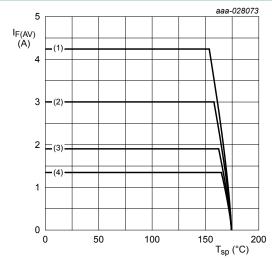
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Average forward current as a function of Fig. 8. ambient temperature; typical values



 $T_i = 175 \, ^{\circ}C$ 

 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

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## 11. Test information

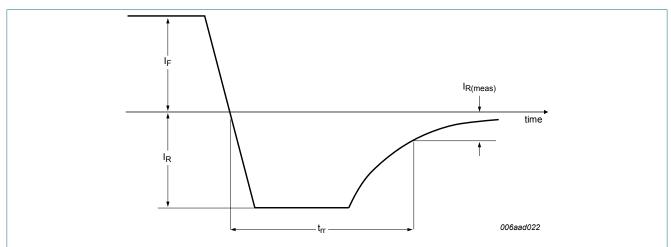


Fig. 11. Reverse recovery definition; step recovery

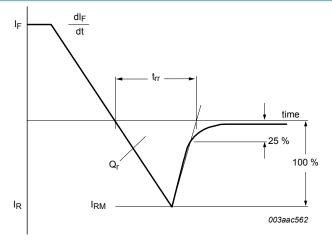


Fig. 12. Reverse recovery definition; ramp recovery

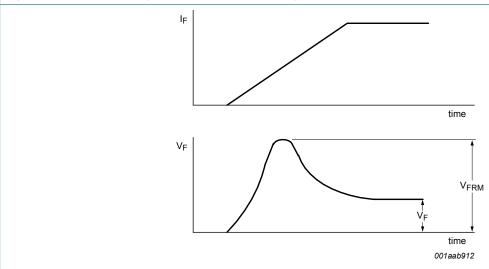
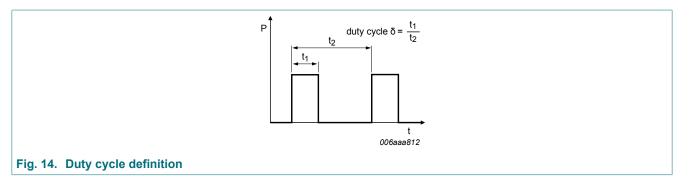


Fig. 13. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,

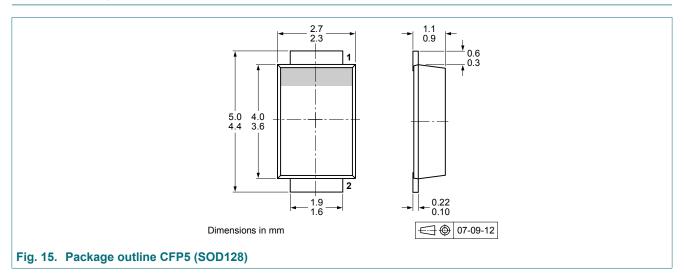
 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with I<sub>RMS</sub> defined as RMS current.

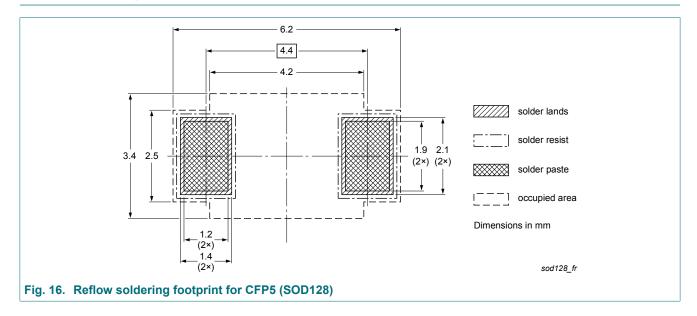
#### **Quality information**

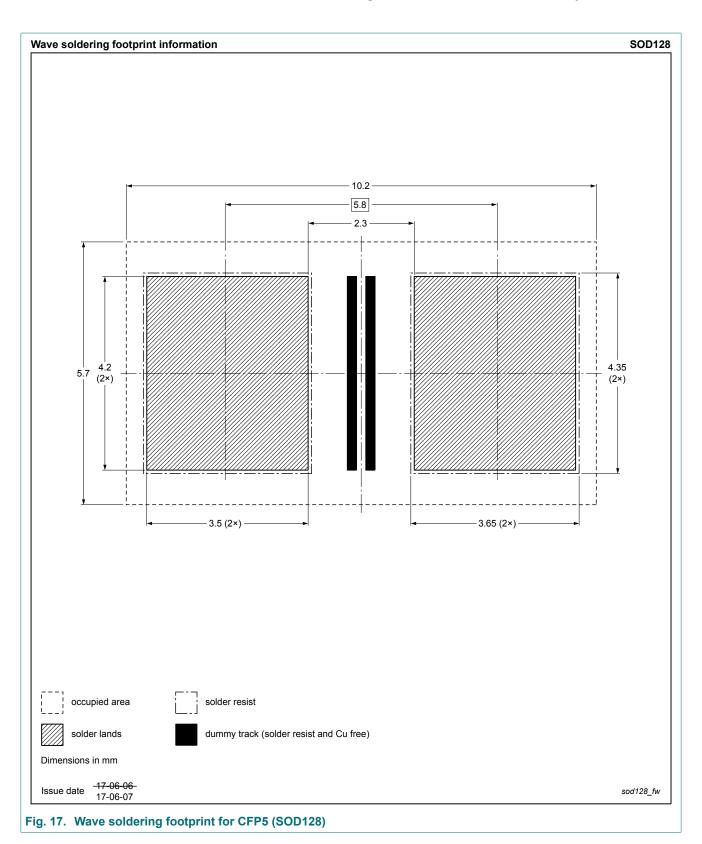
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering





## 14. Revision history

#### Table 8. Revision history

Tuble 6. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG60T30ELP v.2	20180524	Product data sheet	-	PMEG60T30ELP v.1				
Modifications:	Product status changed							
PMEG60T30ELP v.1	20180227	Preliminary data sheet	-	-				

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## 15. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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